The Sustainable Growth of CWTC

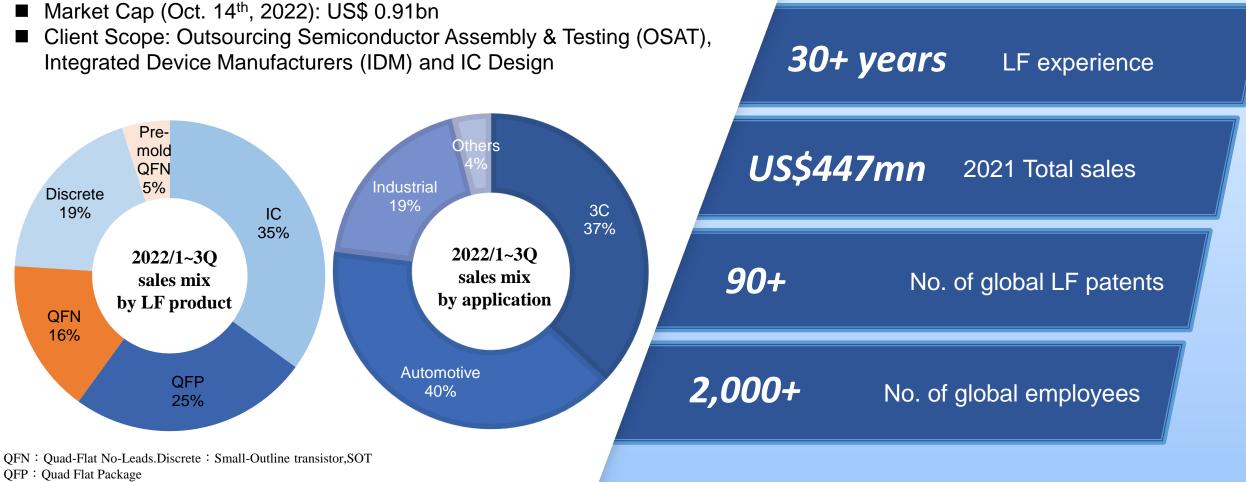
2022 Investor Presentation Canon Huang, Chairman of CWTC (6548 TT)

Forward-looking Statement

Information included in this press release that are not historical in nature are "forward looking statements". CWTC cautions readers that forward looking statements are based on CWTC's reasonable knowledge and current expectations and are subject to various risks and uncertainties. Actual results may differ materially from those contained in such forward looking statements for a variety of reasons including without limitation, risks associated with demand and supply change, manufacturing and supply capacity, design win, time to market, market competition, industrial cyclicality, customer's financial condition, exchange rate fluctuation, legal actions, amendments of the laws and regulations, global economy change, natural disasters, and other unexpected events which may disrupt CWTC's business and operations. Accordingly, readers should not place reliance on any forward looking statements. Except as required by law, CWTC undertakes no obligation to update any forward looking statement, whether as a result of new information, future events, or otherwise.



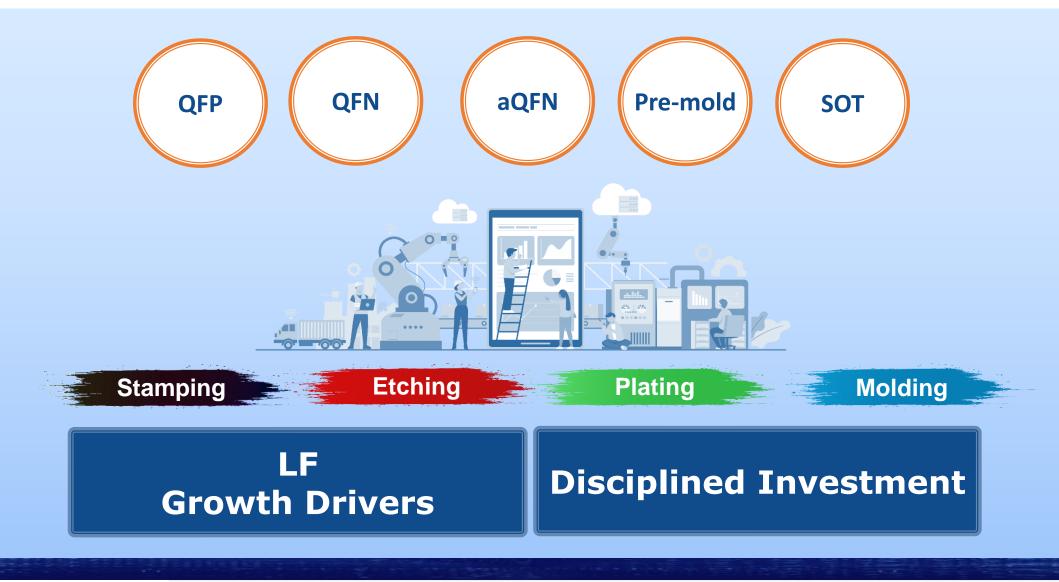
A Leading Lead Frame(LF) Solution Expert





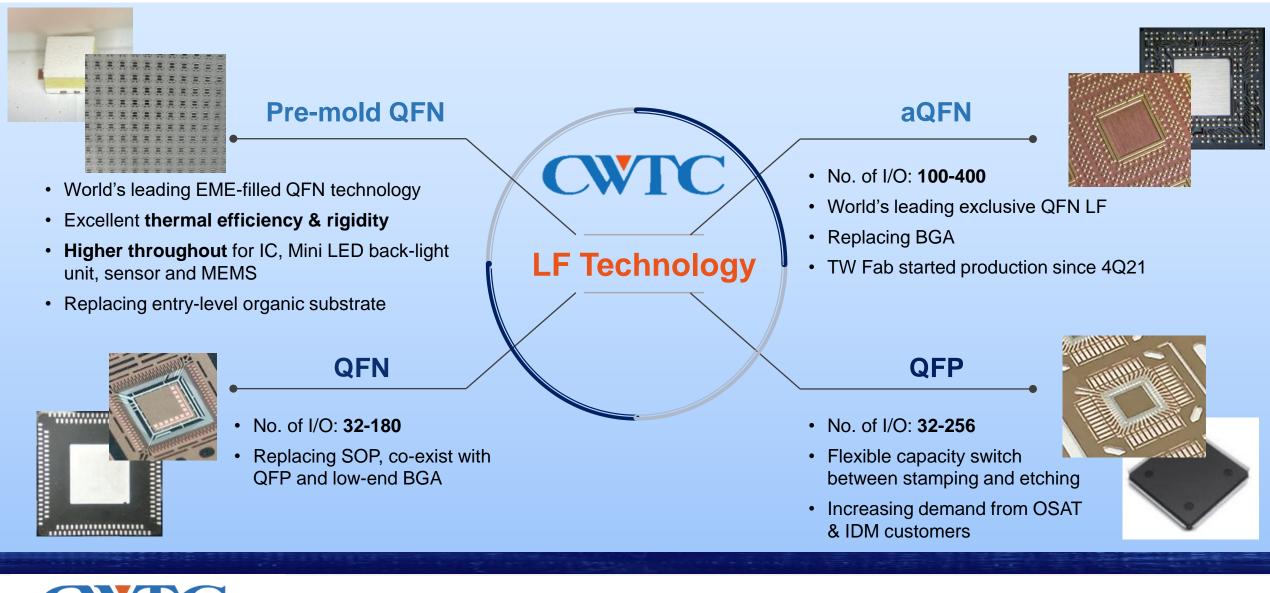
Ticker: 6548 TT

Our Execution Plan





Our Technology Leadership





Lead Frame Growth Drivers

Disciplined Investment

Our Commitments to Shareholders

Financial Performance

Lead Frame Growth Drivers



Our Multiple Applications



Various LF Spec. Requirement: No. of I/O, Form factor, Reliability, Thermal conductivity and Electrical performance



CWTC's Growing Automotive Business

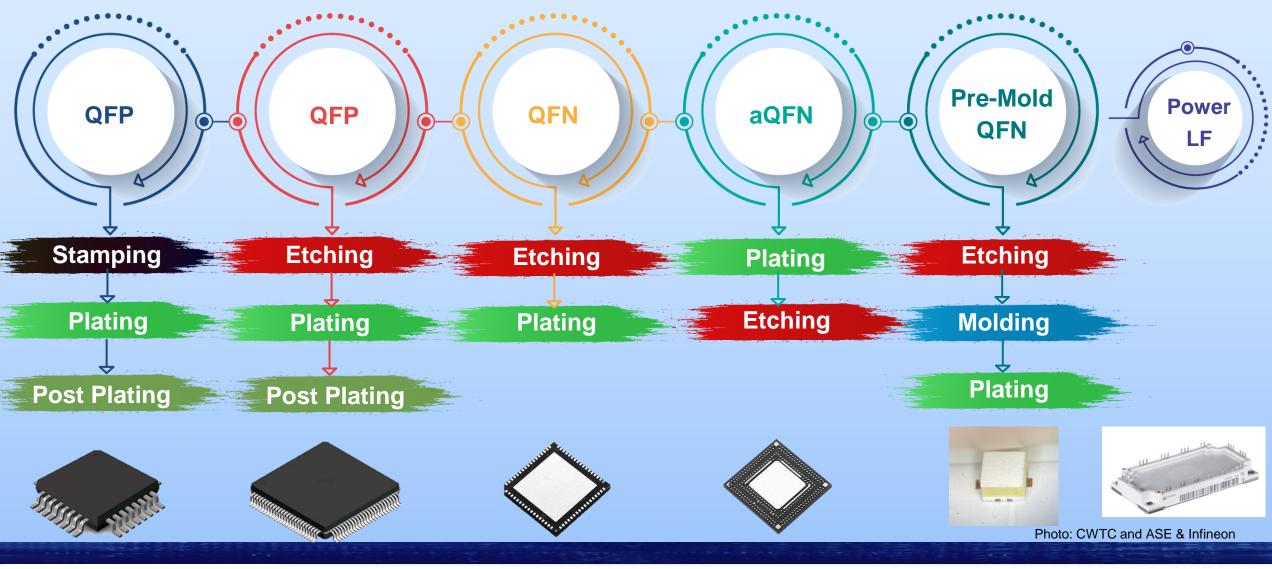
CWTC's automotive sales contribution has increased from 28% in 2018 to 40% in 1~3Q22. We expect automotive lead frame business to continue to be one of growth drivers of our sustainable profitability.



Disciplined Investment



Products Manufacturing Process





Our Commitments to Shareholders



We Aim to Produce the Highest Return in the IC Manufacturing Industry

Through efficient investment in capex and LF diversity, we expect to outgrow the semiconductor manufacturing industry and deliver an ROE in excess of 20% from 2021E to 2025E.

2021E-2025E	Capex-to-Sales ratio	Capex Efficiency*		Sales CAGR	GP CAGR	FCF CAGR
СМТС	Mid-to-High single digit%	2~3x	Capex Efficiency and LF Diversity	Above	e Industry Aver	age
Foundry	36%	0.4x		14%	14%	12%
OSAT	11%	1.0x		7%	8%	24%

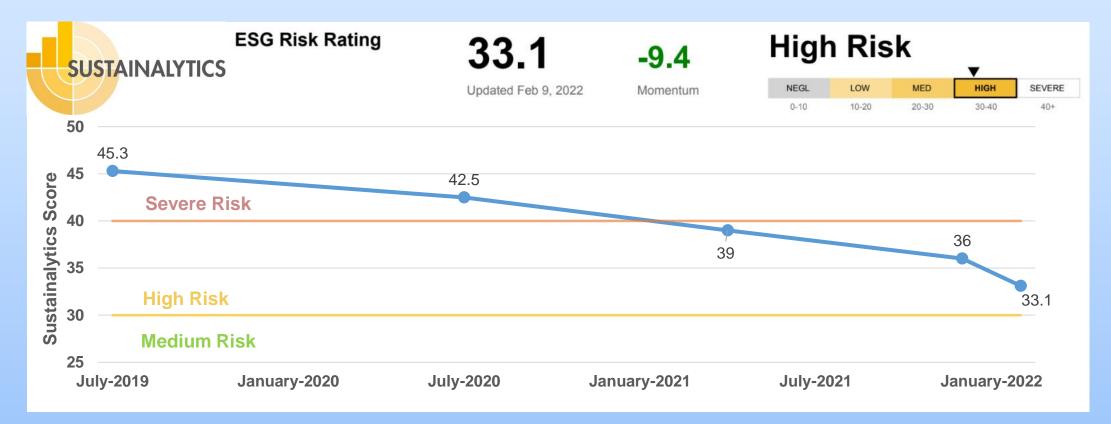
* Capex efficiency: Additional sales in year N+1 / capex in year N

Source: Bloomberg and Gartner. Foundry including TSMC, UMC, VIS while OSAT includes ASE, Powertech, KYEC, Chipbond, ChipMOS and Greatek



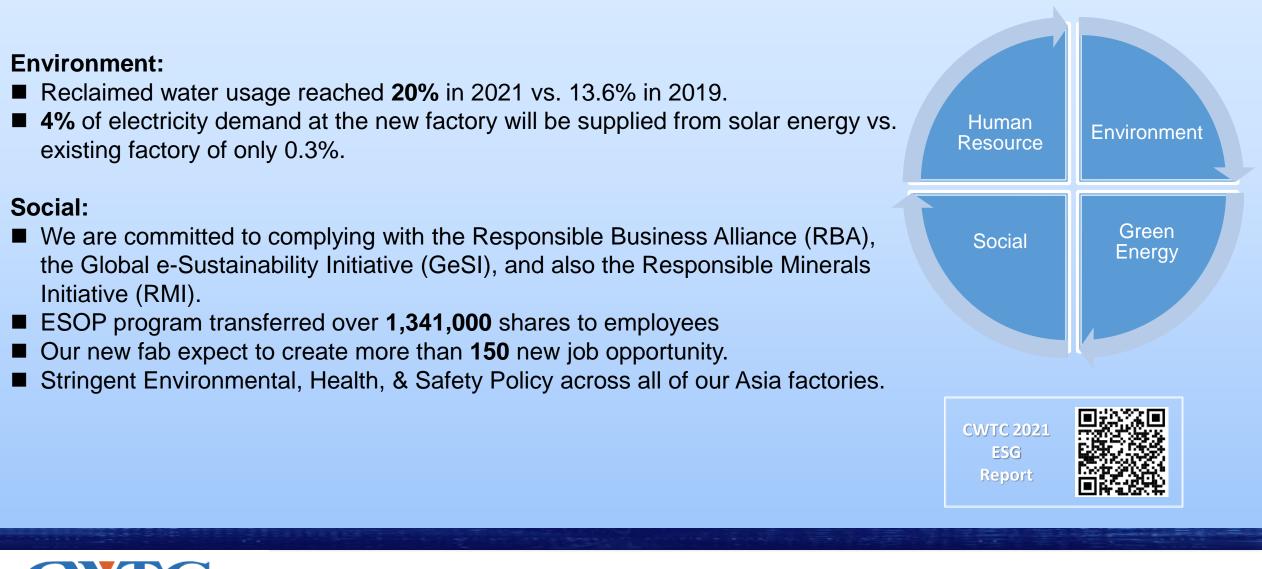
Our Ever-Improving ESG Performance

- Year over year improvement in our Sustainalytics ESG Score
- We expect further improvement into the medium risk category by 2022





We Pursuit Our Sustainable Growth in an Eco-friendly Approach



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Financial Performance

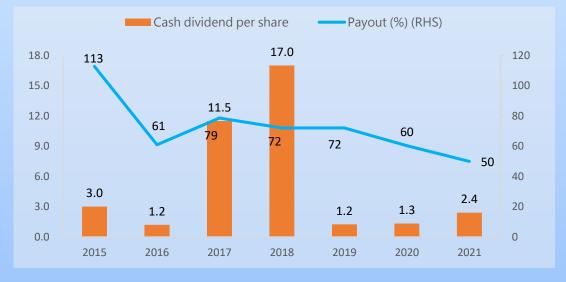


Robust Financial Performance









*Since Sep. 9^{th,} 2019, CWTC changed the par value of stock from NT\$10 to NT\$1. The EPS and dividend are one-tenth of the original numbers.
**Since Sep. 5^{th,} 2022, CWTC changed the par value of stock from NT\$1 to NT\$0.4. The EPS and dividend are two-fifth of the original numbers.
***1~3Q22 financial data is the company's internal self-settled figures and may be changed after being reviewed by the accountant.

2017-1~3Q22 Income Statement

	2017	2018	2019	2020	2021	1~3Q22*** -	YoY (%)					
NT\$mn							2017	2018	2019	2020	2021	1~3Q22***
Revenue	7,505	9,785	9,320	9,678	12,792	11,093	350.0	30.4	-4.7	3.8	32.2	21.6
Gross Profit	1,444	1,802	1,581	1,805	3,406	3,449	559.6	24.8	-12.3	14.2	88.7	59.7
Operating Expenses	- 607	- 708	- 748	- 845	- 1,196	-948	397.9	16.5	5.7	12.9	41.6	32.0
Operating Profit	837	1,094	833	960	2,210	2,501	763.1	30.7	-23.9	15.3	130.1	73.6
Pretax Income	1,071	1,206	899	966	2,249	3,079	362.6	12.6	-25.4	7.5	132.7	110.3
Tax Expenses	- 251	- 354	- 280	- 176	- 511	-631	955.8	40.9	-20.8	-37.3	190.8	93.6
Net Income to Parent	431	843	607	774	1,714	2,426	858.0	95.5	-27.9	27.4	121.5	116.6
Basic EPS (NT\$)	14.62	23.60	1.72*	2.19	4.81	2.59**	642.1	61.4	-*	27.3	119.6	_**
Key Financial Ratios (%)												
Gross Margin	19.2	18.4	17.0	18.6	26.6	31.1						
Operating Expense Ratio	8.1	7.2	8.0	8.7	9.3	8.6						
Operating Margin	11.1	11.2	8.9	9.9	17.3	22.5						
Effect Tax Rate	23.4	29.3	31.2	18.2	22.7	27.8						
Net Margin	5.7	8.6	6.5	8.0	13.6	22.1						

*Since Sep. 9^{th,} 2019, CWTC changed the par value of stock from NT\$10 to NT\$1. The EPS and dividend are one-tenth of the original numbers. **Since Sep. 5^{th,} 2022, CWTC changed the par value of stock from NT\$1 to NT\$0.4. The EPS and dividend are two-fifth of the original numbers. ***1~3Q22 financial data is the company's internal self-settled figures and may be changed after being reviewed by the accountant.

2017-1~3Q22 Balance Sheet

NT¢ es e	2017	2018	2019	2020	2021	1~3Q22*	YoY (%)					
NT\$mn							2017	2018	2019	2020	2021	1~3Q22*
Total Assets	9,100	9,788	10,544	12,164	14,842	18,738	290.1	7.6	7.7	15.4	22.0	31.0
Cash	2,131	2,304	3,076	2,502	3,796	4,942	244.7	8.1	33.5	-18.7	51.7	39.3
AR & NR	1,825	1,927	2,003	2,114	2,858	3,103	248.6	5.6	4.0	5.5	35.2	15.1
Inventories	1,267	1,437	1,296	1,437	2,196	2,645	1456.6	13.4	-9.8	10.9	52.9	30.9
Fixed Assets	2,318	2,441	2,210	2,252	2,475	3,468	615.4	5.3	-9.5	1.9	9.9	44.6
Total Liabilities	3,970	4,617	5,558	6,738	6,430	8,181	1229.0	16.3	20.4	21.2	-4.6	7.8
AP & NP	957	1,019	1,148	1,105	1,337	1,240	430.7	6.5	12.6	-3.8	21.0	-6.9
Total Equity	5,130	5,171	4,986	5,426	8,412	10,557	152.2	0.8	-3.6	8.8	55.0	57.1
Key Financial Ratios												
A/R Turnover Days	56.3	69.0	75.9	76.6	70.0	73.6						
Inventory Turnover Days	40.0	61.0	63.5	62.5	69.7	86.7						
A/P Turnover Days	33.8	44.6	50.4	51.5	21.2	46.1						
Cash Conversion Days	62.6	85.4	89.0	87.5	118.4	114.2						
ROE (%)	12.0	16.4	12.0	14.9	24.8	26.3						
ROA (%)	7.5	8.9	6.0	6.8	12.7	14.7						



Appendix



Glossary

- SO/SOP: Small Outline and Small Outline Package
- TSSOP: Thin Shrink Small Outline Package
- TSOP: Thin Small Outline Package
- COL: Chip-n-Lead
- QFP: Quad Flat Package
- SQFP: Small Quad Flat Package
- TQFP: Thin profile Quad Flat Package
- LQFP: Low profile Quad Flat Package
- PDIP: Plastic Dual In-line Package
- PLCC: Plastic Leaded Chip Carrier
- VSO: Very Small Outline Package
- PMFP: Plastic Micro Flat Package
- BCC: Bump Chip Carrier
- QFN: Quad Flat No-lead
- DRQFN: Dual Row Quad Flat No-Lead Package
- aQFN: advanced Quad Flat No-lead
- VQFN: Very Thin Quad Flat No-lead Package